



Customer Information Notification

2025060261 : i.MX 8QuadMax, i.MX 8QuadPlus FCPBGA1313 and i.MX 8QuadXPlus, i.MX 8DualXPlus, i.MX 8DualX FCPBGA609 Qualification of Additional Lid Supplier at ATK4

Note: This notice is NXP Company Proprietary.

Issue Date: Jul 03, 2025 **Effective Date:** Aug 04, 2025

Dear Gordon Love,

Here is your personalized communication about an NXP notification.
For detailed information we invite you to [view this notification online](#)

Change Category

- | | | | | |
|--|---|--|--|---|
| <input type="checkbox"/> Wafer
Fab
Process | <input type="checkbox"/> Assembly
Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test
Process | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer
Fab
Materials | <input checked="" type="checkbox"/> Assembly
Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test
Equipment | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer
Fab
Location | <input type="checkbox"/> Assembly
Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test
Location | <input type="checkbox"/> Electrical
spec./Test
coverage |
| <input type="checkbox"/> Firmware <input type="checkbox"/> Other | | | | |

Notification Overview

Description

NXP Semiconductors announces the Qualification of additional lid supplier for the i.MX 8QuadMax, i.MX 8QuadPlus FCPBGA1313 and i.MX 8QuadXPlus, i.MX 8DualXPlus, i.MX 8DualX FCPBGA609 devices listed in this notification.

There is no impact to the fit, function, reliability, or quality between current lid and additional lid supplier.

However, there is slight visual difference.

The additional lid supplier was successfully qualified adhering to NXP specifications.

Please see the attached file(s) for additional details.

Corresponding ZVEI Delta Qualification Matrix ID: SEM-PA-16

Reason

Qualification of additional lid supplier is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Additional information

Additional documents: [view online](#)

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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